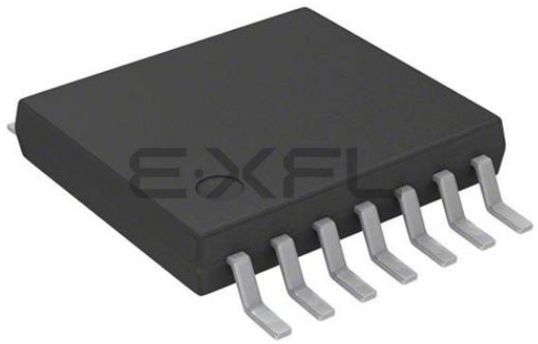

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	LINbus, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 8x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1575-i-st

TABLE 3-7: PIC16(L)F1574/8 MEMORY MAP, BANKS 8-15

BANK 8		BANK 9		BANK 10		BANK 11		BANK 12		BANK 13		BANK 14		BANK 15	
400h	Core Registers (Table 3-2)	480h	Core Registers (Table 3-2)	500h	Core Registers (Table 3-2)	580h	Core Registers (Table 3-2)	600h	Core Registers (Table 3-2)	680h	Core Registers (Table 3-2)	700h	Core Registers (Table 3-2)	780h	Core Registers (Table 3-2)
40Bh		48Bh		50Bh		58Bh		60Bh		68Bh		70Bh		78Bh	
40Ch	—	48Ch	—	50Ch	—	58Ch	—	60Ch	—	68Ch	—	70Ch	—	78Ch	—
40Dh	—	48Dh	—	50Dh	—	58Dh	—	60Dh	—	68Dh	—	70Dh	—	78Dh	—
40Eh	—	48Eh	—	50Eh	—	58Eh	—	60Eh	—	68Eh	—	70Eh	—	78Eh	—
40Fh	—	48Fh	—	50Fh	—	58Fh	—	60Fh	—	68Fh	—	70Fh	—	78Fh	—
410h	—	490h	—	510h	—	590h	—	610h	—	690h	—	710h	—	790h	—
411h	—	491h	—	511h	—	591h	—	611h	—	691h	CWG1DBR	711h	—	791h	—
412h	—	492h	—	512h	—	592h	—	612h	—	692h	CWG1DBF	712h	—	792h	—
413h	—	493h	—	513h	—	593h	—	613h	—	693h	CWG1CON0	713h	—	793h	—
414h	—	494h	—	514h	—	594h	—	614h	—	694h	CWG1CON1	714h	—	794h	—
415h	—	495h	—	515h	—	595h	—	615h	—	695h	CWG1CON2	715h	—	795h	—
416h	—	496h	—	516h	—	596h	—	616h	—	696h	—	716h	—	796h	—
417h	—	497h	—	517h	—	597h	—	617h	—	697h	—	717h	—	797h	—
418h	—	498h	—	518h	—	598h	—	618h	—	698h	—	718h	—	798h	—
419h	—	499h	—	519h	—	599h	—	619h	—	699h	—	719h	—	799h	—
41Ah	—	49Ah	—	51Ah	—	59Ah	—	61Ah	—	69Ah	—	71Ah	—	79Ah	—
41Bh	—	49Bh	—	51Bh	—	59Bh	—	61Bh	—	69Bh	—	71Bh	—	79Bh	—
41Ch	—	49Ch	—	51Ch	—	59Ch	—	61Ch	—	69Ch	—	71Ch	—	79Ch	—
41Dh	—	49Dh	—	51Dh	—	59Dh	—	61Dh	—	69Dh	—	71Dh	—	79Dh	—
41Eh	—	49Eh	—	51Eh	—	59Eh	—	61Eh	—	69Eh	—	71Eh	—	79Eh	—
41Fh	—	49Fh	—	51Fh	—	59Fh	—	61Fh	—	69Fh	—	71Fh	—	79Fh	—
420h	Unimplemented Read as '0'	4A0h	Unimplemented Read as '0'	520h	Unimplemented Read as '0'	5A0h	Unimplemented Read as '0'	620h	Unimplemented Read as '0'	6A0h	Unimplemented Read as '0'	720h	Unimplemented Read as '0'	7A0h	Unimplemented Read as '0'
46Fh		4EFh		56Fh		5EFh		66Fh		6EFh		76Fh		7EFh	
470h	Accesses 70h – 7Fh	4F0h	Accesses 70h – 7Fh	570h	Accesses 70h – 7Fh	5F0h	Accesses 70h – 7Fh	670h	Accesses 70h – 7Fh	6F0h	Accesses 70h – 7Fh	770h	Accesses 70h – 7Fh	7F0h	Accesses 70h – 7Fh
47Fh		4FFh		57Fh		5FFh		67Fh		6FFh		77Fh		7FFh	

Legend: = Unimplemented data memory locations, read as '0'

TABLE 3-10: PIC16(L)F1574/5/8/9 MEMORY MAP, BANKS 24-31

BANK 24		BANK 25		BANK 26		BANK 27		BANK 28		BANK 29		BANK 30		BANK 31	
C00h	Core Registers (Table 3-2)	C80h	Core Registers (Table 3-2)	D00h	Core Registers (Table 3-2)	D80h	Core Registers (Table 3-2)	E00h	Core Registers (Table 3-2)	E80h	Core Registers (Table 3-2)	F00h	Core Registers (Table 3-2)	F80h	Core Registers (Table 3-2)
C0Bh		C8Bh		D0Bh		D8Bh		E0Bh		E8Bh		F0Bh		F8Bh	
C0Ch	—	C8Ch	—	D0Ch	—	D8Ch	See Table 3-11	E0Ch	See Table 3-12	E8Ch	See Table 3-12	F0Ch	—	F8Ch	See Table 3-13
C0Dh	—	C8Dh	—	D0Dh	—							F0Dh	—		
C0Eh	—	C8Eh	—	D0Eh	—							F0Eh	—		
C0Fh	—	C8Fh	—	D0Fh	—							F0Fh	—		
C10h	—	C90h	—	D10h	—							F10h	—		
C11h	—	C91h	—	D11h	—							F11h	—		
C12h	—	C92h	—	D12h	—							F12h	—		
C13h	—	C93h	—	D13h	—							F13h	—		
C14h	—	C94h	—	D14h	—							F14h	—		
C15h	—	C95h	—	D15h	—							F15h	—		
C16h	—	C96h	—	D16h	—							F16h	—		
C17h	—	C97h	—	D17h	—							F17h	—		
C18h	—	C98h	—	D18h	—							F18h	—		
C19h	—	C99h	—	D19h	—							F19h	—		
C1Ah	—	C9Ah	—	D1Ah	—							F1Ah	—		
C1Bh	—	C9Bh	—	D1Bh	—							F1Bh	—		
C1Ch	—	C9Ch	—	D1Ch	—							F1Ch	—		
C1Dh	—	C9Dh	—	D1Dh	—							F1Dh	—		
C1Eh	—	C9Eh	—	D1Eh	—							F1Eh	—		
C1Fh	—	C9Fh	—	D1Fh	—							F1Fh	—		
C20h	Unimplemented Read as ‘0’	CA0h	Unimplemented Read as ‘0’	D20h	Unimplemented Read as ‘0’							F20h	Unimplemented Read as ‘0’		
C6Fh		CEFh		D6Fh		DEFh		E6Fh		EEFh		F6Fh		FEFh	
C70h	Accesses 70h – 7Fh	CF0h	Accesses 70h – 7Fh	D70h	Accesses 70h – 7Fh	DF0h	Accesses 70h – 7Fh	E70h	Accesses 70h – 7Fh	EF0h	Accesses 70h – 7Fh	F70h	Accesses 70h – 7Fh	FF0h	Accesses 70h – 7Fh
CFFh		CFFh		D7Fh		DFFh		E7Fh		EFFh		F7Fh		FFFh	

Legend: = Unimplemented data memory locations, read as ‘0’

TABLE 3-15: SPECIAL FUNCTION REGISTER SUMMARY

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 0											
00Ch	PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	--xx xxxx	--xx xxxx
00Dh	PORTB(1)	RB7	RB6	RB5	RB4	—	—	—	—	xxxx ----	xxxx ----
00Eh	PORTC	RC7(1)	RC6(1)	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	xxxx xxxx
00Fh	—	Unimplemented								—	—
010h	—	Unimplemented								—	—
011h	PIR1	TMR1GIF	ADIF	RCIF	TXIF	—	—	TMR2IF	TMR1IF	0000 --00	0000 --00
012h	PIR2	—	C2IF	C1IF	—	—	—	—	—	-00- ----	-00- ----
013h	PIR3	PWM4IF	PWM3IF	PWM2IF	PWM1IF	—	—	—	—	0000 ----	0000 ----
014h	—									—	—
015h	TMR0	Holding Register for the 8-bit Timer0 Count								xxxx xxxx	uuuu uuuu
016h	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Count								xxxx xxxx	uuuu uuuu
017h	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Count								xxxx xxxx	uuuu uuuu
018h	T1CON	TMR1CS<1:0>		T1CKPS<1:0>		—	$\overline{\text{T1SYNC}}$	—	TMR1ON	0000 -0-0	uuuu -u-u
019h	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	$\overline{\text{T1GGO}}$/ $\overline{\text{DONE}}$	T1GVAL	T1GSS<1:0>		0000 0x00	uuuu uxuu
01Ah	TMR2	Timer2 Module Register								0000 0000	0000 0000
01Bh	PR2	Timer2 Period Register								1111 1111	1111 1111
01Ch	T2CON	—	T2OUTPS<3:0>				TMR2ON	T2CKPS<1:0>		-000 0000	-000 0000
01Dh	—	Unimplemented								—	—
01Eh	—	Unimplemented								—	—
01Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.
Note 1: PIC16(L)F1578/9 only.
2: PIC16F1574/5/8/9 only.
3: Unimplemented, read as '1'.

TABLE 3-15: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 4											
20Ch	WPUA	—	—	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	--11 1111	--11 1111
20Dh	WPUB(1)	WPUB7	WPUB6	WPUB5	WPUB4	—	—	—	—	1111 ----	1111 ----
20Eh	WPUC	WPUC7(1)	WPUC6(1)	WPUC5	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0	1111 1111	1111 1111
20Fh to 21Fh	—	Unimplemented								—	—
Bank 5											
28Ch	ODCONA	—	—	ODA5	ODA4	—	ODA2	ODA1	ODA0	--00 -000	--00 -000
28Dh	ODCONB(1)	ODB7	ODB6	ODB5	ODB4	—	—	—	—	0000 ----	0000 ----
28Eh	ODCONC	ODC7(1)	ODC6(1)	ODC5	ODC4	ODC3	ODC2	ODC1	ODC0	0000 0000	0000 0000
28Fh to 29Fh	—	Unimplemented								—	—
Bank 6											
30Ch	SLRCONA	—	—	SLRA5	SLRA4	—	SLRA2	SLRA1	SLRA0	--11 -111	--11 -111
30Dh	SLRCONB(1)	SLRB7	SLRB6	SLRB5	SLRB4	—	—	—	—	1111 ----	1111 ----
30Eh	SLRCONC	SLRC7(1)	SLRC6(1)	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0	1111 1111	1111 1111
30Fh to 31Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.
Note 1: PIC16(L)F1578/9 only.
2: PIC16F1574/5/8/9 only.
3: Unimplemented, read as '1'.

REGISTER 5-2: OSCSTAT: OSCILLATOR STATUS REGISTER

U-0	R-0/q	R-q/q	R-0/q	R-0/q	R-q/q	R-0/q	R-0/q
—	PLLR	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Conditional

bit 7 **Unimplemented:** Read as ‘0’

bit 6 **PLLR** 4x PLL Ready bit
1 = 4x PLL is ready
0 = 4x PLL is not ready

bit 5 **OSTS:** Oscillator Start-up Timer Status bit
1 = Running from the clock defined by the FOSC<1:0> bits of the Configuration Words
0 = Running from an internal oscillator (FOSC<1:0> = 00)

bit 4 **HFIOFR:** High-Frequency Internal Oscillator Ready bit
1 = HFINTOSC is ready
0 = HFINTOSC is not ready

bit 3 **HFIOFL:** High-Frequency Internal Oscillator Locked bit
1 = HFINTOSC is at least 2% accurate
0 = HFINTOSC is not 2% accurate

bit 2 **MFIOFR:** Medium-Frequency Internal Oscillator Ready bit
1 = MFINTOSC is ready
0 = MFINTOSC is not ready

bit 1 **LFIOFR:** Low-Frequency Internal Oscillator Ready bit
1 = LFINTOSC is ready
0 = LFINTOSC is not ready

bit 0 **HFIOFS:** High-Frequency Internal Oscillator Stable bit
1 = HFINTOSC is at least 0.5% accurate
0 = HFINTOSC is not 0.5% accurate

6.1 Power-On Reset (POR)

The POR circuit holds the device in Reset until VDD has reached an acceptable level for minimum operation. Slow rising VDD, fast operating speeds or analog performance may require greater than minimum VDD. The PWRT, BOR or MCLR features can be used to extend the start-up period until all device operation conditions have been met.

6.1.1 POWER-UP TIMER (PWRT)

The Power-up Timer provides a nominal 64 ms time-out on POR or Brown-out Reset.

The device is held in Reset as long as PWRT is active. The PWRT delay allows additional time for the VDD to rise to an acceptable level. The Power-up Timer is enabled by clearing the PWRTE bit in Configuration Words.

The Power-up Timer starts after the release of the POR and BOR.

For additional information, refer to Application Note AN607, *"Power-up Trouble Shooting"* (DS00607).

6.2 Brown-Out Reset (BOR)

The BOR circuit holds the device in Reset when VDD reaches a selectable minimum level. Between the POR and BOR, complete voltage range coverage for execution protection can be implemented.

The Brown-out Reset module has four operating modes controlled by the BOREN<1:0> bits in Configuration Words. The four operating modes are:

- BOR is always on
- BOR is off when in Sleep
- BOR is controlled by software
- BOR is always off

Refer to Table 6-1 for more information.

The Brown-out Reset voltage level is selectable by configuring the BORV bit in Configuration Words.

A VDD noise rejection filter prevents the BOR from triggering on small events. If VDD falls below VBOR for a duration greater than parameter TBORDC, the device will reset. See Figure 6-2 for more information.

TABLE 6-1: BOR OPERATING MODES

BOREN<1:0>	SBOREN	Device Mode	BOR Mode	Instruction Execution upon: Release of POR or Wake-up from Sleep
11	X	X	Active	Waits for BOR ready(1) (BORRDY = 1)
10	X	Awake	Active	Waits for BOR ready (BORRDY = 1)
		Sleep	Disabled	
01	1	X	Active	Waits for BOR ready(1) (BORRDY = 1)
	0	X	Disabled	Begins immediately (BORRDY = x)
00	X	X	Disabled	

Note 1: In these specific cases, "release of POR" and "wake-up from Sleep," there is no delay in start-up. The BOR ready flag, (BORRDY = 1), will be set before the CPU is ready to execute instructions because the BOR circuit is forced on by the BOREN<1:0> bits.

6.2.1 BOR IS ALWAYS ON

When the BOREN bits of Configuration Words are programmed to '11', the BOR is always on. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is active during Sleep. The BOR does not delay wake-up from Sleep.

6.2.2 BOR IS OFF IN SLEEP

When the BOREN bits of Configuration Words are programmed to '10', the BOR is on, except in Sleep. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is not active during Sleep. The device wake-up will be delayed until the BOR is ready.

6.2.3 BOR CONTROLLED BY SOFTWARE

When the BOREN bits of Configuration Words are programmed to '01', the BOR is controlled by the SBOREN bit of the BORCON register. The device start-up is not delayed by the BOR ready condition or the VDD level.

BOR protection begins as soon as the BOR circuit is ready. The status of the BOR circuit is reflected in the BORRDY bit of the BORCON register.

BOR protection is unchanged by Sleep.

REGISTER 11-3: LATA: PORTA DATA LATCH REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	U-0	R/W-x/u	R/W-x/u	R/W-x/u
—	—	LATA5	LATA4	—	LATA2	LATA1	LATA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **LATA<5:4>**: RA<5:4> Output Latch Value bits(1)

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **LATA<2:0>**: RA<2:0> Output Latch Value bits(1)

Note 1: Writes to PORTA are actually written to corresponding LATA register. Reads from PORTA register is return of actual I/O pin values.

REGISTER 11-4: ANSELA: PORTA ANALOG SELECT REGISTER

U-0	U-0	U-0	R/W-1/1	U-0	R/W-1/1	R/W-1/1	R/W-1/1
—	—	—	ANSA4	—	ANSA2	ANSA1	ANSA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **ANSA4**: Analog Select between Analog or Digital Function on pins RA4, respectively
1 = Analog input. Pin is assigned as analog input(1). Digital input buffer disabled.
0 = Digital I/O. Pin is assigned to port or digital special function.

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **ANSA<2:0>**: Analog Select between Analog or Digital Function on pins RA<2:0>, respectively
1 = Analog input. Pin is assigned as analog input(1). Digital input buffer disabled.
0 = Digital I/O. Pin is assigned to port or digital special function.

Note 1: When setting a pin to an analog input, the corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

REGISTER 11-22: ODCONC: PORTC OPEN DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODC7(1)	ODC6(1)	ODC5	ODC4	ODC3	ODC2	ODC1	ODC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ODC<7:0>:** PORTC Open-Drain Enable bits(1)
For RC<7:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

Note 1: ODC<7:6> are available on PIC16(L)F1578/9 only.

REGISTER 11-23: SLRCONC: PORTC SLEW RATE CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SLRC7(1)	SLRC6(1)	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **SLRC<7:0>:** PORTC Slew Rate Enable bits(1)
For RC<7:0> pins, respectively
1 = Port pin slew rate is limited
0 = Port pin slews at maximum rate

Note 1: SLRC<7:6> are available on PIC16(L)F1578/9 only.

REGISTER 11-24: INLVLC: PORTC INPUT LEVEL CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
INLVLC7(1)	INLVLC6(1)	INLVLC5	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **INLVLC<7:0>:** PORTC Input Level Select bits(1)
For RC<7:0> pins, respectively
1 = ST input used for port reads and interrupt-on-change
0 = TTL input used for port reads and interrupt-on-change

Note 1: INLVLC<7:6> are available on PIC16(L)F1578/9 only.

12.3 Bidirectional Pins

PPS selections for peripherals with bidirectional signals on a single pin must be made so that the PPS input and PPS output select the same pin. Peripherals that have bidirectional signals include:

- EUSART (synchronous operation)
- MSSP (I^2C)

Note:	The I^2C default input pins are I^2C and SMBus compatible and are the only pins on the device with this compatibility.

12.4 PPS Lock

The PPS includes a mode in which all input and output selections can be locked to prevent inadvertent changes. PPS selections are locked by setting the PPSLOCKED bit of the PPSLOCK register. Setting and clearing this bit requires a special sequence as an extra precaution against inadvertent changes. Examples of setting and clearing the PPSLOCKED bit are shown in Example 12-1.

EXAMPLE 12-1: PPS LOCK/UNLOCK SEQUENCE

```
; suspend interrupts
    bcf     INTCON,GIE
;   BANKSEL PPSLOCK     ; set bank
; required sequence, next 5 instructions
    movlw   0x55
    movwf   PPSLOCK
    movlw   0xAA
    movwf   PPSLOCK
; Set PPSLOCKED bit to disable writes or
; Clear PPSLOCKED bit to enable writes
    bsf     PPSLOCK,PPSLOCKED
; restore interrupts
    bsf     INTCON,GIE
```

12.5 PPS Permanent Lock

The PPS can be permanently locked by setting the PPS1WAY Configuration bit. When this bit is set, the PPSLOCKED bit can only be cleared and set one time after a device Reset. This allows for clearing the PPSLOCKED bit so that the input and output selections can be made during initialization. When the PPSLOCKED bit is set after all selections have been made, it will remain set and cannot be cleared until after the next device Reset event.

12.6 Operation During Sleep

PPS input and output selections are unaffected by Sleep.

12.7 Effects of a Reset

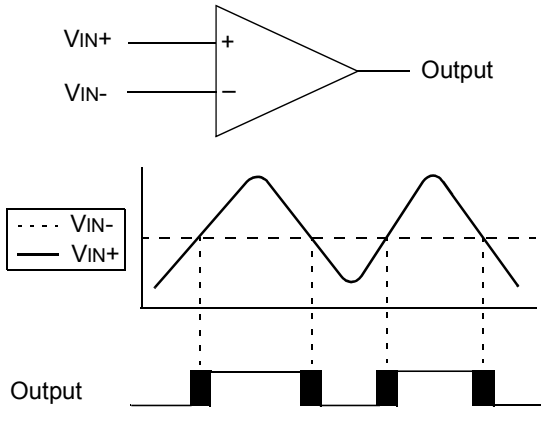
A device Power-On-Reset (POR) clears all PPS input and output selections to their default values. All other Resets leave the selections unchanged. Default input selections are shown in Table 12-1.

TABLE 12-3: SUMMARY OF REGISTERS ASSOCIATED WITH THE PPS MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
PPSLOCK	—	—	—	—	—	—	—	PPSLOCKED	138
INTPPS	—	—	—	INTPPS<4:0>					137
T0CKIPPS	—	—	—	T0CKIPPS<4:0>					137
T1CKIPPS	—	—	—	T1CKIPPS<4:0>					137
T1GPPS	—	—	—	T1GPPS<4:0>					137
CWG1INPPS	—	—	—	CWG1INPPS<4:0>					137
RXPPS	—	—	—	RXPPS<4:0>					137
CKPPS	—	—	—	CKPPS<4:0>					137
ADCACTPPS	—	—	—	ADCACTPPS<4:0>					137
RA0PPS	—	—	—	—	RA0PPS<3:0>				137
RA1PPS	—	—	—	—	RA1PPS<3:0>				137
RA2PPS	—	—	—	—	RA2PPS<3:0>				137
RA4PPS	—	—	—	—	RA4PPS<3:0>				137
RA5PPS	—	—	—	—	RA5PPS<3:0>				137
RB4PPS(1)	—	—	—	—	RB4PPS<3:0>				137
RB5PPS(1)	—	—	—	—	RB5PPS<3:0>				137
RB6PPS(1)	—	—	—	—	RB6PPS<3:0>				137
RB7PPS(1)	—	—	—	—	RB7PPS<3:0>				137
RC0PPS	—	—	—	—	RC0PPS<3:0>				137
RC1PPS	—	—	—	—	RC1PPS<3:0>				137
RC2PPS	—	—	—	—	RC2PPS<3:0>				137
RC3PPS	—	—	—	—	RC3PPS<3:0>				137
RC4PPS	—	—	—	—	RC4PPS<3:0>				137
RC5PPS	—	—	—	—	RC5PPS<3:0>				137
RC6PPS(1)	—	—	—	—	RC6PPS<3:0>				137
RC7PPS(1)	—	—	—	—	RC7PPS<3:0>				137

Note 1: PIC16(L)F1578/9 only.

FIGURE 18-2: SINGLE COMPARATOR



Note: The black areas of the output of the comparator represents the uncertainty due to input offsets and response time.

18.2 Comparator Control

The comparator has two control registers: CMxCON0 and CMxCON1.

The CMxCON0 register (see Register 18-1) contains Control and Status bits for the following:

- Enable
- Output selection
- Output polarity
- Speed/Power selection
- Hysteresis enable
- Output synchronization

The CMxCON1 register (see Register 18-2) contains Control bits for the following:

- Interrupt enable
- Interrupt edge polarity
- Positive input channel selection
- Negative input channel selection

18.2.1 COMPARATOR ENABLE

Setting the CxON bit of the CMxCON0 register enables the comparator for operation. Clearing the CxON bit disables the comparator resulting in minimum current consumption.

18.2.2 COMPARATOR POSITIVE INPUT SELECTION

Configuring the CxPCH<1:0> bits of the CMxCON1 register directs an internal voltage reference or an analog pin to the non-inverting input of the comparator:

- CxIN+ analog pin
- DAC1_output
- FVR_buffer2
- Vss

See **Section 14.0 "Fixed Voltage Reference (FVR)"** for more information on the Fixed Voltage Reference module.

See **Section 17.0 "5-Bit Digital-to-Analog Converter (DAC) Module"** for more information on the DAC input signal.

Any time the comparator is disabled (CxON = 0), all comparator inputs are disabled.

18.2.3 COMPARATOR NEGATIVE INPUT SELECTION

The CxNCH<2:0> bits of the CMxCON0 register direct one of the input sources to the comparator inverting input.

Note: To use CxIN+ and CxINx- pins as analog input, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

18.2.4 COMPARATOR OUTPUT SELECTION

The output of the comparator can be monitored by reading either the CxOUT bit of the CMxCON0 register or the MCxOUT bit of the CMOUT register. In order to make the output available for an external connection, the following conditions must be true:

- Corresponding TRIS bit must be cleared
- CxON bit of the CMxCON0 register must be set

The synchronous comparator output signal (CxOUT_sync) is available to the following peripheral(s):

- Analog-to-Digital Converter (ADC)
- Timer1

The asynchronous comparator output signal (CxOUT_async) is available to the following peripheral(s):

- Complementary Waveform Generator (CWG)

Note: The internal output of the comparator is latched with each instruction cycle. Unless otherwise specified, external outputs are not latched.

23.2 PWM Modes

PWM Modes are selected with MODE<1:0> bits of the PWMxCON register (Register 23-1).

In all PWM modes an offset match event can also be used to synchronize the PWMxTMR in three offset modes. See **Section 23.3 "Offset Modes"** for more information.

23.2.1 STANDARD MODE

The Standard mode (MODE = 00) selects a single phase PWM output. The PWM output in this mode is determined by when the period, duty cycle, and phase counts match the PWMxTMR value. The start of the duty cycle occurs on the phase match and the end of the duty cycle occurs on the duty cycle match. The period match resets the timer. The offset match can also be used to synchronize the PWMxTMR in the offset modes. See **Section 23.3 "Offset Modes"** for more information.

Equation 23-1 is used to calculate the PWM period in Standard mode.

Equation 23-2 is used to calculate the PWM duty-cycle ratio in Standard mode.

EQUATION 23-1: PWM PERIOD IN STANDARD MODE

$$Period = \frac{(PWMxPR + 1) \cdot Prescale}{PWMxCLK}$$

EQUATION 23-2: PWM DUTY CYCLE IN STANDARD MODE

$$Duty\ Cycle = \frac{(PWMxDC - PWMxPH)}{PWMxPR + 1}$$

A detailed timing diagram for Standard mode is shown in Figure 23-4.

23.2.2 SET ON MATCH MODE

The Set On Match mode (MODE = 01) generates an active output when the phase count matches the PWMxTMR value. The output stays active until the OUT bit of the PWMxCON register is cleared or the PWM module is disabled. The duty cycle count has no effect in this mode. The period count only determines the maximum PWMxTMR value above which no phase matches can occur.

The PWMxOUT bit can be used to set or clear the output of the PWM in this mode. Writes to this bit will take place on the next rising edge of the PWM_clock after the bit is written.

A detailed timing diagram for Set On Match is shown in Figure 23-5.

23.2.3 TOGGLE ON MATCH MODE

The Toggle On Match mode (MODE = 10) generates a 50% duty cycle PWM with a period twice as long as that computed for the standard PWM mode. Duty cycle count has no effect in this mode. The phase count determines how many PWMxTMR periods after a period event the output will toggle.

Writes to the OUT bit of the PWMxCON register will have no effect in this mode.

A detailed timing diagram for Toggle On Match is shown in Figure 23-6.

23.2.4 CENTER-ALIGNED MODE

The Center-Aligned mode (MODE = 11) generates a PWM waveform that is centered in the period. In this mode the period is two times the PWMxPR count. The PWMxTMR counts up to the period value then counts back down to 0. The duty cycle count determines both the start and end of the active PWM output. The start of the duty cycle occurs at the match event when PWMxTMR is incrementing and the duty cycle ends at the match event when PWMxTMR is decrementing. The incrementing match value is the period count minus the duty cycle count. The decrementing match value is the incrementing match value plus 1.

Equation 23-3 is used to calculate the PWM period in Center-Aligned mode.

EQUATION 23-3: PWM PERIOD IN CENTER-ALIGNED MODE

$$Period = \frac{(PWMxPR + 1) \cdot Prescale \cdot 2}{PWMxCLK}$$

Equation 23-4 is used to calculate the PWM duty cycle ratio in Center-Aligned mode

EQUATION 23-4: PWM DUTY CYCLE IN CENTER-ALIGNED MODE

$$Duty\ Cycle = \frac{PWMxDC \cdot 2}{(PWMxPR + 1) \cdot 2}$$

Writes to PWMxOUT will have no effect in this mode.

A detailed timing diagram for Center-Aligned mode is shown in Figure 23-7.

FIGURE 23-13: OFFSET MATCH ON DECREMENTING TIMER TIMING DIAGRAM

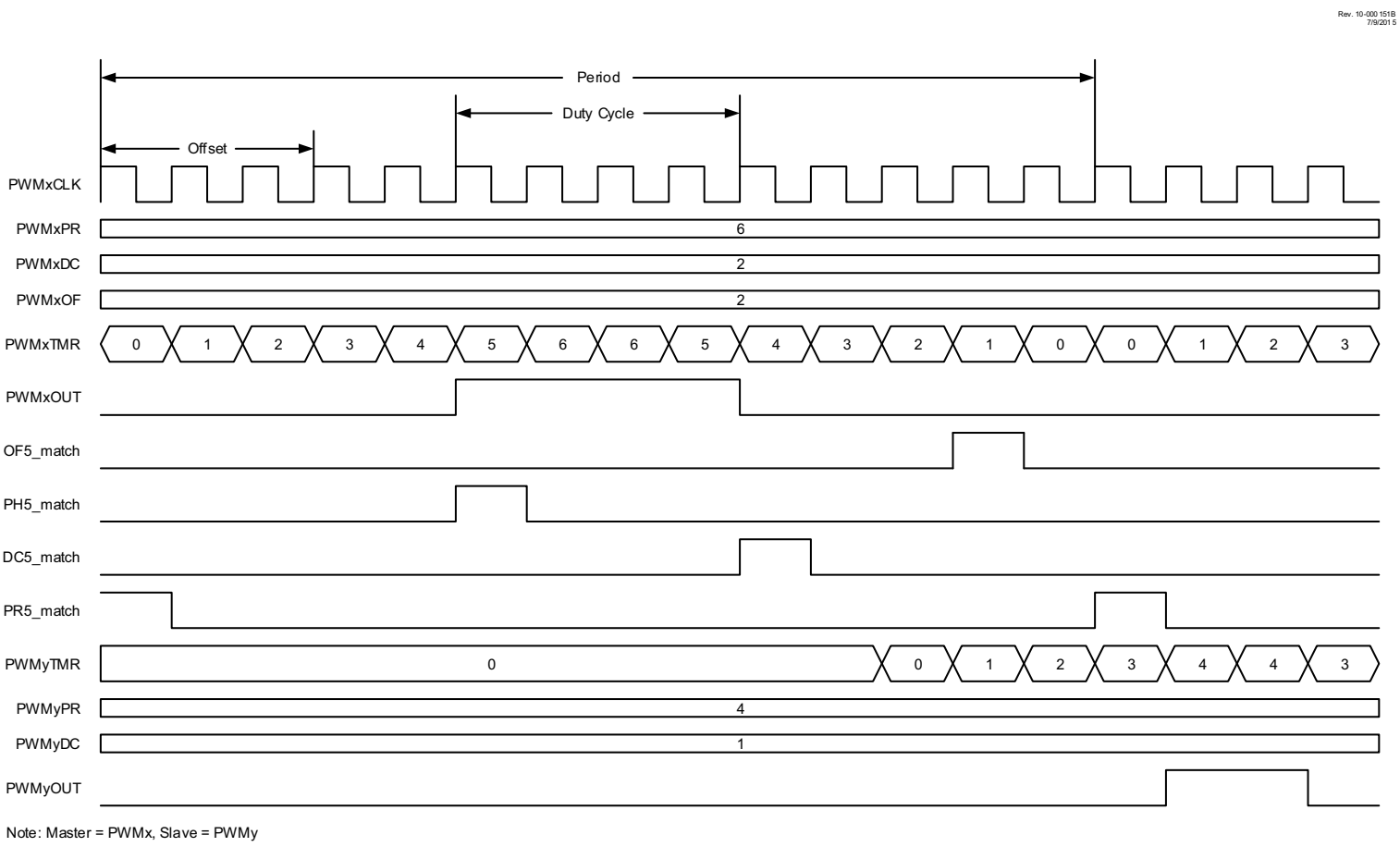


TABLE 23-2: SUMMARY OF REGISTERS ASSOCIATED WITH PWM (CONTINUED)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PWM3CLKCON	—	PS<2:0>			—	—	CS<1:0>		235
PWM3LDCON	LDA	LDT	—	—	—	—	LDS<1:0>		236
PWM3OFCON	—	OFM<1:0>		OFO	—	—	OFS<1:0>		237
PWM4PHL	PH<7:0>								238
PWM4PHH	PH<15:8>								238
PWM4DCL	DC<7:0>								239
PWM4DCH	DC<15:8>								239
PWM4PRL	PR<7:0>								240
PWM4PRH	PR<15:8>								240
PWM4OFL	OF<7:0>								241
PWM4OFH	OF<15:8>								241
PWM4TMRL	TMR<7:0>								242
PWM4TMRH	TMR<15:8>								242
PWM4CON	EN	—	OUT	POL	MODE<1:0>		—	—	233
PWM4INTE	—	—	—	—	OFIE	PHIE	DCIE	PRIE	234
PWM4INTF	—	—	—	—	OFIF	PHIF	DCIF	PRIF	234
PWM4CLKCON	—	PS<2:0>			—	—	CS<1:0>		235
PWM4LDCON	LDA	LDT	—	—	—	—	LDS<1:0>		236
PWM4OFCON	—	OFM<1:0>		OFO	—	—	OFS<1:0>		237

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by PWM.

TABLE 23-3: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	—	—	$\overline{\text{CLKOUTEN}}$	BOREN<1:0>		—	56
	7:0	$\overline{\text{CP}}$	MCLRE	$\overline{\text{PWRTE}}$	WDTE<1:0>		—	FOSC<1:0>		

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

REGISTER 24-4: CWGxDBR: COMPLEMENTARY WAVEFORM GENERATOR (CWGx) RISING DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	CWG**x**DBR<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **CWGxDBR<5:0>:** Complementary Waveform Generator (CWGx) Rising Counts

11 1111 = 63-64 counts of dead band
11 1110 = 62-63 counts of dead band

•
•
•

00 0010 = 2-3 counts of dead band
00 0001 = 1-2 counts of dead band
00 0000 = 0 counts of dead band

REGISTER 24-5: CWGxDBF: COMPLEMENTARY WAVEFORM GENERATOR (CWGx) FALLING DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	CWGxDBF<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **CWGxDBF<5:0>:** Complementary Waveform Generator (CWGx) Falling Counts

11 1111 = 63-64 counts of dead band
11 1110 = 62-63 counts of dead band

•
•
•

00 0010 = 2-3 counts of dead band
00 0001 = 1-2 counts of dead band
00 0000 = 0 counts of dead band. Dead-band generation is bypassed.

25.0 IN-CIRCUIT SERIAL PROGRAMMING™ (ICSP™)

ICSP™ programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP™ programming:

- ICSPCLK
- ICSPDAT
- $\overline{MCLR}$/VPP
- VDD
- VSS

In Program/Verify mode the program memory, user IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. For more information on ICSP™ refer to the "*PIC16(L)F157x Memory Programming Specification*" (DS40001766).

25.1 High-Voltage Programming Entry Mode

The device is placed into High-Voltage Programming Entry mode by holding the ICSPCLK and ICSPDAT pins low then raising the voltage on $\overline{MCLR}$/VPP to VIHH.

25.2 Low-Voltage Programming Entry Mode

The Low-Voltage Programming Entry mode allows the PIC® Flash MCUs to be programmed using VDD only, without high voltage. When the LVP bit of Configuration Words is set to '1', the ICSP Low-Voltage Programming Entry mode is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'.

Entry into the Low-Voltage Programming Entry mode requires the following steps:

1. $\overline{MCLR}$ is brought to VIL.
2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

Once the key sequence is complete, $\overline{MCLR}$ must be held at VIL for as long as Program/Verify mode is to be maintained.

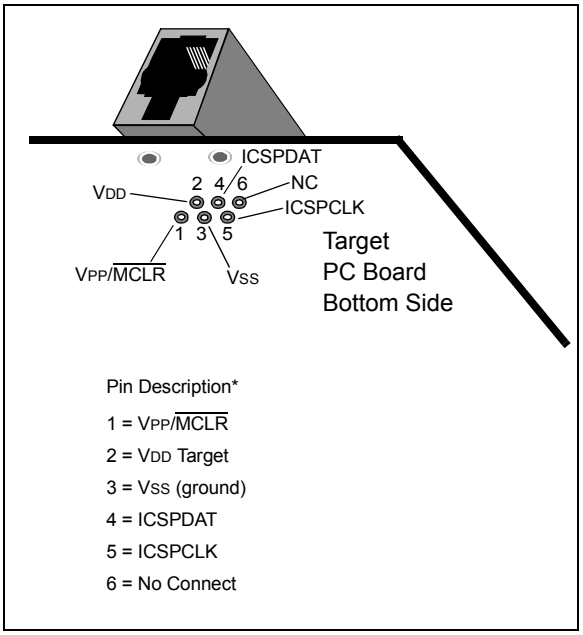
If low-voltage programming is enabled (LVP = 1), the $\overline{MCLR}$ Reset function is automatically enabled and cannot be disabled. See **Section 6.5 "MCLR"** for more information.

The LVP bit can only be reprogrammed to '0' by using the High-Voltage Programming mode.

25.3 Common Programming Interfaces

Connection to a target device is typically done through an ICSP™ header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6-pin, 6-connector) configuration. See Figure 25-1.

FIGURE 25-1: ICD RJ-11 STYLE CONNECTOR INTERFACE



Another connector often found in use with the PICkit™ programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 25-2.

TABLE 27-8: OSCILLATOR PARAMETERS

Standard Operating Conditions (unless otherwise stated)								
Param. No.	**Sym.**	**Characteristic**	**Freq. Tolerance**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
OS08	HFOSC	Internal Calibrated HFINTOSC Frequency(1)	±2%	—	16.0	—	MHz	VDD = 3.0V, TA = 25°C, **(Note 2)**
OS09	LFOSC	Internal LFINTOSC Frequency	—	—	31	—	kHz	
OS10*	TWARM	HFINTOSC Wake-up from Sleep Start-up Time	—	—	5	15	µs	
		LFINTOSC Wake-up from Sleep Start-up Time	—	—	0.5	—	ms	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: To ensure these oscillator frequency tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

2: See Figure 27-6: "HFINTOSC Frequency Accuracy over Device VDD and Temperature.

FIGURE 27-6: HFINTOSC FREQUENCY ACCURACY OVER DEVICE VDD AND TEMPERATURE

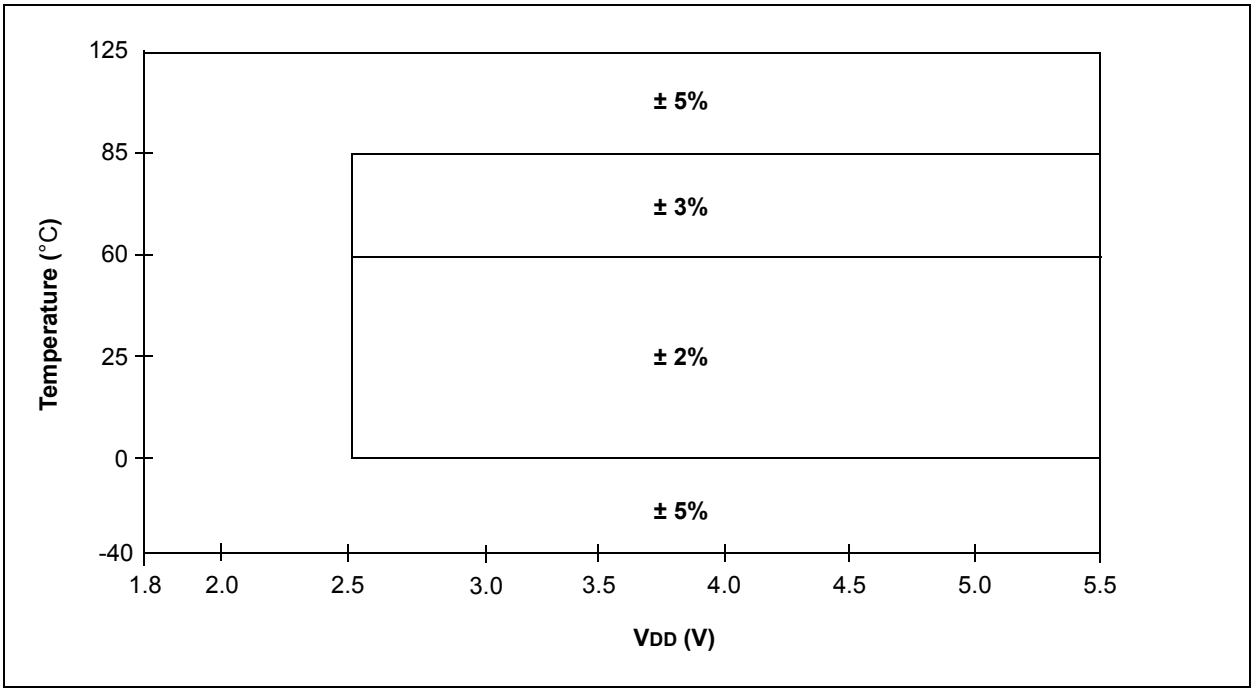


TABLE 27-9: PLL CLOCK TIMING SPECIFICATIONS (VDD = 2.7V TO 5.5V)

Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
F10	FOSC	Oscillator Frequency Range	4	—	8	MHz	
F11	FSYS	On-Chip VCO System Frequency	16	—	32	MHz	
F12	TRC	PLL Start-up Time (Lock Time)	—	—	2	ms	
F13*	ΔCLK	CLKOUT Stability (Jitter)	-0.25%	—	+0.25%	%	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 27-13: ANALOG-TO-DIGITAL CONVERTER (ADC) CHARACTERISTICS(1,2,3)

Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
AD01	NR	Resolution	—	—	10	bit	
AD02	EIL	Integral Error	—	±1	±1.7	LSb	VREF = 3.0V
AD03	EDL	Differential Error	—	±1	±1	LSb	No missing codes VREF = 3.0V
AD04	EOFF	Offset Error	—	±1	±2.5	LSb	VREF = 3.0V
AD05	EGN	Gain Error	—	±1	±2.0	LSb	VREF = 3.0V
AD06	VREF	Reference Voltage	1.8	—	VDD	V	VREF = (VRPOS - VRNEG) (**Note 4**)
AD07	VAIN	Full-Scale Range	VSS	—	VREF	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	Can go higher if external 0.01μF capacitor is present on input pin.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error includes integral, differential, offset and gain errors.

2: The ADC conversion result never decreases with an increase in the input voltage and has no missing codes.

3: See **Section 28.0 "DC and AC Characteristics Graphs and Charts"** for operating characterization.

4: ADC VREF is selected by ADPREF<0> bit.

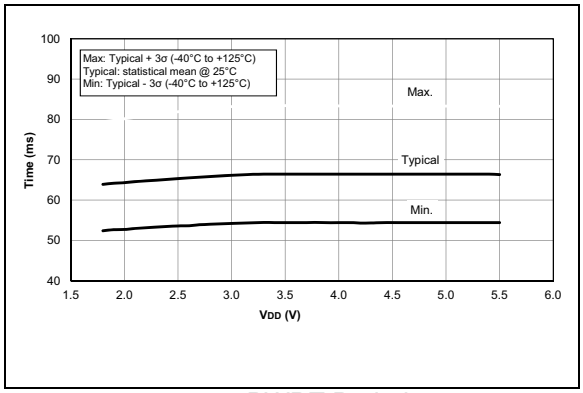


FIGURE 28-55: *PWRT Period.*

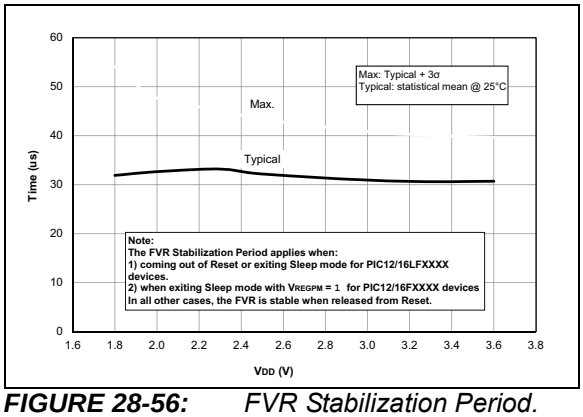


FIGURE 28-56: *FVR Stabilization Period.*

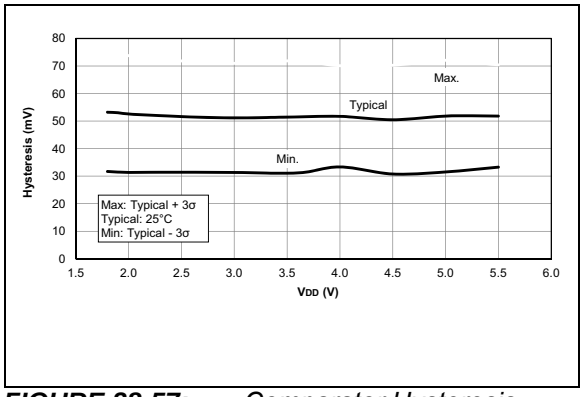


FIGURE 28-57: *Comparator Hysteresis, Normal Power Mode (CxSP = 1, CxHYS = 1).*

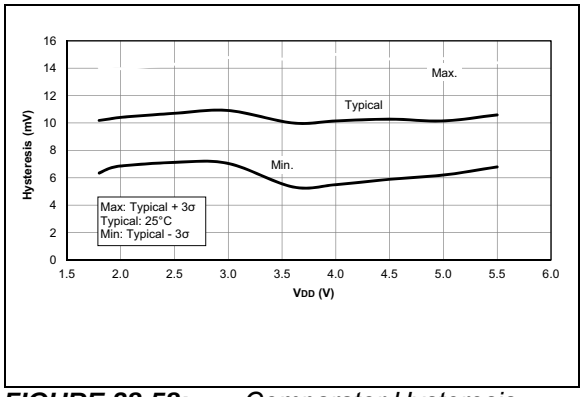


FIGURE 28-58: *Comparator Hysteresis, Low-Power Mode (CxSP = 0, CxHYS = 1).*

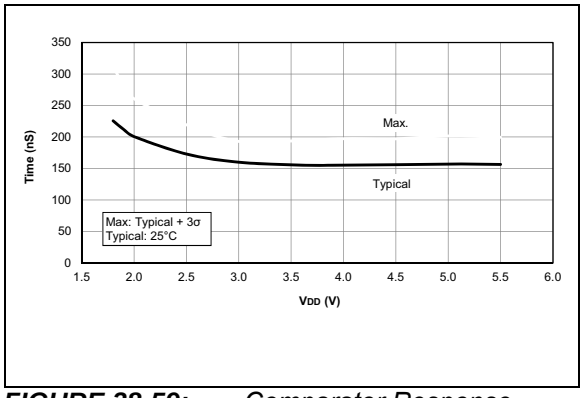


FIGURE 28-59: *Comparator Response Time, Normal Power Mode, (CxSP = 1).*

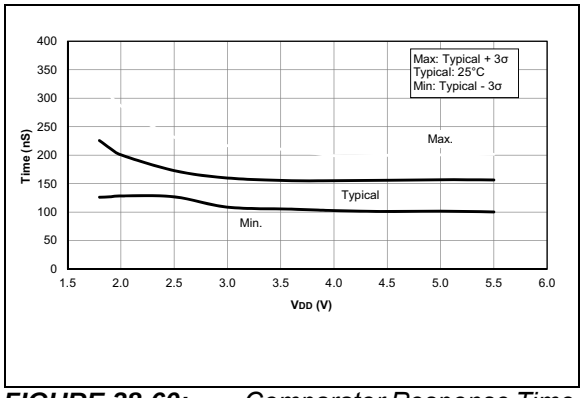
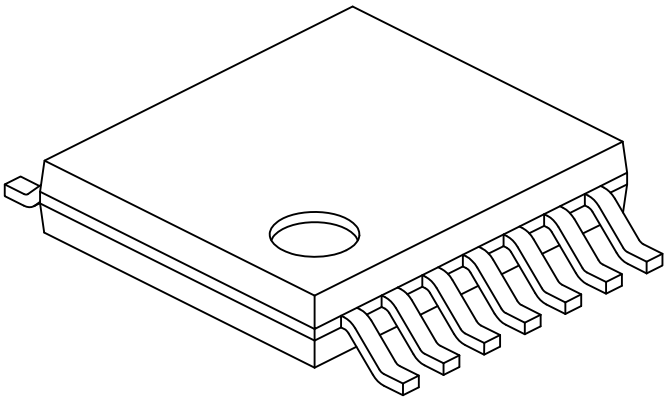


FIGURE 28-60: *Comparator Response Time Over Temperature, Normal Power Mode, (CxSP = 1).*

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	e		0.65 BSC	
Overall Height	A	-	-	1.20
Molded Package Thickness	A2	0.80	1.00	1.05
Standoff	A1	0.05	-	0.15
Overall Width	E		6.40 BSC	
Molded Package Width	E1	4.30	4.40	4.50
Molded Package Length	D	4.90	5.00	5.10
Foot Length	L	0.45	0.60	0.75
Footprint	(L1)		1.00 REF	
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.09	-	0.20
Lead Width	b	0.19	-	0.30

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-087C Sheet 2 of 2